

Table 2-1. Model 472 Wafer Polisher Specifications Overview

PARAMETER	SPECIFICATION
POWER	208, 380, 460 Vac, 3 phase, 50/60 Hz
DI WATER	Peak Flow: 12 gallons per minute (gpm) (45.4 l/min) Average Flow: 6 gpm (22.7 l/min) Pressure: 25 to 30 psi, minimum
CHILLED WATER	Peak Flow: 5 gpm (18.9 l/min)
COMPRESSED AIR	Peak Flow: 6 standard cubic feet per minute (SCFM) (170 SLM)
NITROGEN	Peak Flow 10 SCFM (283 SLM)
DIMENSIONS	Width: 207.62 in (5273.55 mm) Depth: 131.74 in (3346.20 mm) Height: 92.0 in (2336.8 mm) Weight: Approximately 7500 lbs. (3410 Kg)